

LAST: 10/6/2010 10:00 AM

File Edit View Options Database Help

Database: C:\PROGRAMS\LEAD\LEAD.DAT

Table: HEATSINK

Field: L13

Value: (140166) 5 near 4 12

Field: L14

Value: (3993) 11 and 13

Field: L15

Value: (25226) flip adj chip

Field: L16

Value: (4832329) copper cu aluminum al

Field: L17

Value: (105237) 5 near 8 16

Field: L18

Value: (1570) 14 and 17

Field: L19

Value: (451) 18 and 15

Field: L20

Value: (718522) bump ball

Field: L21

Value: (50915) 20 near 9 2

Field: L22

Value: (1753597) (adhe\$6 glue)

Field: L23

Value: (4156) 2 with 3 with 22

Field: L24

Value: (223) 19 and 23

Field: L25

Value: (192) 24 and 21

Field: L26

Value: (1) 10/766210

Field: L27

Value: (24844) dovetail

Field: L28

Value: (0) 28 and 25

Field: L29

Value: (57) 3 near 9 27

Field: L30

Value: (275) 5 near 9 27

Field: L31

Value: (0) 30 and 25

Field: L32

Value: (5) 14 and 30

Field: L33

Value: (7) 11 and 30

Field: L34

Value: (41545) 9 and 10

Field: L35

Value: (396) 5 with 27

Field: L36

Value: (16) 34 and 35

34 and 35

Feb. 2005

U	I	Inventor	Document	Issue	P	Title	Current	Current X	Retrieve	S	C	P	Image	Do	P
1		Bartley, Oe	US 608477	2000	7	Heatsink and package structures with	361/770	165/80.3							US 608477
2		Lee, Yong	US 200402	2004	1	Flip chip package having protective ca	257/77								US 200402
3		Arnold, Roc	US 200402	2004	3	Electromagnetic interference shielding	361/80								US 200402
4		Homung, C	US 200402	2004	1	Dual material heat sink core assembly	361/770								US 200402
5		Soule, Chri	US 200302	2003	1	Stacked fin heat sink and method of m	257/770	257/E23.1							US 200302
6		Lin, Yu-Se	US 200301	2003	1	Heat sink for heat-susceptible electron	165/80	257/E23.0							US 200301
7		Patel, Chan	US 200201	2002	1	Cooling plate arrangement for electron	361/770								US 200201
8		Patek, Chan	US 668712	2004	1	Cooling plate arrangement for electron	361/770	361/687							US 668712
9		Innes, Rob	US 644426	2002	1	Apparatus and method for coating she	427/35	118/123							US 644426
10		Lipinski, Jo	US 563871	1997	1	Method and apparatus for fabricating	72/178	29/890.03							US 563871